### DATA SHEET

# PHOTOCOUPLER PS9817A-1,-2

#### HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE 8-PIN SSOP (SO-8) HIGH-SPEED PHOTOCOUPLER

-NEPOC Series-

#### DESCRIPTION

NEC

The PS9817A-1 and PS9817A-2 are active-low type high-speed photocouplers that use a GaAlAs light-emitting diode on the input side and a photodetector IC that includes a photodiode and a signal processor on the same chip on the output side.

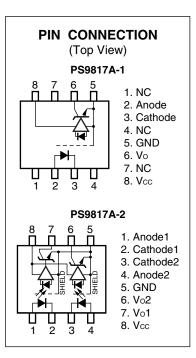
The PS9817A-1 and PS9817A-2 are designed specifically for high common mode transient immunity (CMR) and low pulse width distortion. The PS9817A-2 is suitable for high density applications.

#### **FEATURES**

- Pulse width distortion ( $|t_{PHL}-t_{PLH}| = 35 \text{ ns MAX.}$ )
- High common mode transient immunity (CMH, CML =  $\pm 15 \text{ kV}/\mu \text{s}$  MIN.)
- 40% reduction of mounting area (5-pin SOP × 2)
- High-speed (10 Mbps)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Open collector output
- Ordering number of tape product : PS9817A-1-F3: 1 500 pcs/reel
  - : PS9817A-2-F3: 1 500 pcs/reel
- Pb-Free product
- <R> Safety standards
  - UL approved: File No. E72422
  - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008347 (Option)

#### APPLICATIONS

- Measurement equipment
- PDP
- FA Network



#### TRUTH TABLE

LED	Output		
ON	L		
OFF	Н		

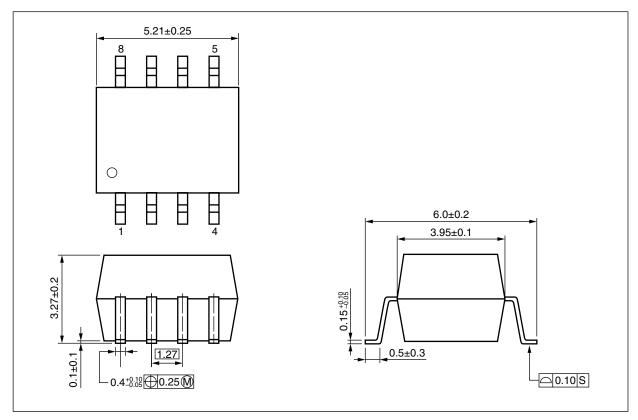
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The mark <R> shows major revised points.

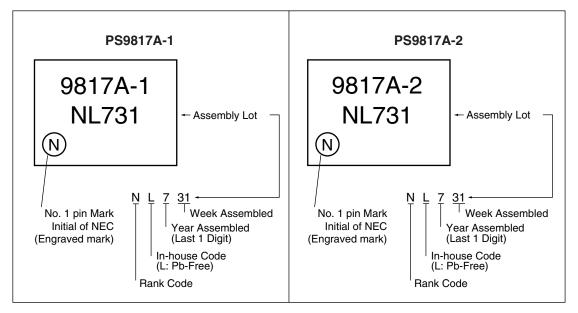
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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

#### PACKAGE DIMENSIONS (UNIT: mm)



#### MARKING EXAMPLE



#### **ORDERING INFORMATION**

Part Number	Order Number	Solder plating specification	Packing Style	Safety Standards Approval	Application Part Number <sup>⁺1</sup>
PS9817A-1	PS9817A-1-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9817A-1
PS9817A-1-F3	PS9817A-1-F3-A		Embossed Tape 1 500 pcs/reel	(UL approved)	
PS9817A-2	PS9817A-2-A		20 pcs (Tape 20 pcs cut)		PS9817A-2
PS9817A-2-F3	PS9817A-2-F3-A		Embossed Tape 1 500 pcs/reel		
PS9817A-1-V	PS9817A-1-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	PS9817A-1
PS9817A-1-V-F3	PS9817A-1-V-F3-A		Embossed Tape 1 500 pcs/reel	(VDE0884 Part2)	
PS9817A-2-V	PS9817A-2-V-A		20 pcs (Tape 20 pcs cut)	approved	PS9817A-2
PS9817A-2-V-F3	PS9817A-2-V-F3-A		Embossed Tape 1 500 pcs/reel	(Option)	

\*1 For the application of the Safety Standard, following part number should be used.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS9817A-1	PS9817A-2	
Diode	Forward Current	lf	20 "	15 <sup>*2</sup>	mA/ch
	Reverse Voltage	VR	Į	5	V/ch
Detector	Supply Voltage	Vcc	7		V
	Output Voltage	Vo	7		V/ch
	Output Current	lo	25		mA/ch
	Power Dissipation <sup>3</sup>	Pc	40		mW/ch
Isolation Voltage <sup>*4</sup>		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85		°C
Storage -	Femperature	Tstg	-55 to +125		°C

\*1 Reduced to 0.3 mA/°C at  $T_A = 60^{\circ}C$  or more.

\*2 Reduced to 0.1 mA/°C at  $T_A = 60°C$  or more.

- \*3 Applies to output pin Vo (collector pin). Reduced to 1.5 mW/°C at TA =  $65^{\circ}$ C or more.
- \*4 AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.

#### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	VFL	0		0.8	V
High Level Input Current	IFH	6.3	10	12.5	mA
Supply Voltage	Vcc	4.5		5.5	V
Pull-up Resistance	R∟	330		4 k	Ω
TLL (R <sub>L</sub> = 1.0 k $\Omega$ , loads)	N			5	

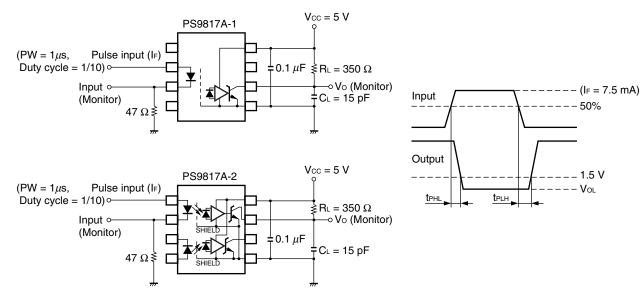
#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = -40 to +85°C, unless otherwise specified)

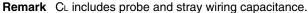
	Parameter	Symbol	Conditions	MIN.	TYP. <sup>*1</sup>	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, T <sub>A</sub> = 25°C	1.4	1.65	1.8	V
Reverse Current		IR	$V_{R} = 3.0 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$			10	μA
	Terminal Capacitance	Ct	VF = 0 V, f = 1 MHz, TA = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5.5 V, VF = 0.8 V		1	100	μA
	Low Level Output Voltage <sup>*2</sup>	Vol	Vcc = 5.5 V, I⊧ = 5.0 mA, Io∟ = 13 mA		0.2	0.6	V
	High Level Supply Current (PS9817A-1)	Іссн	$V_{CC} = 5.5 \text{ V}, \text{ I}_{F} = 0 \text{ mA}, \text{ V}_{O} = \text{open}$		4	7	mA
	High Level Supply Current (PS9817A-2)				8	14	
	Low Level Supply Current (PS9817A-1)	lcc∟	$V_{CC} = 5.5 \text{ V}, \text{ I}_F = 10 \text{ mA}, \text{ V}_O = \text{open}$		6	10	
	Low Level Supply Current (PS9817A-2)				12	20	
Coupled	upled Threshold Input Current $I_{FHL}$ $V_{CC} = 5.0 \text{ V}, \text{ V}_{O} = 0.8 \text{ V}, \text{ R}_{L} = 350 \text{ G}$		$V_{\text{CC}} = 5.0 \text{ V}, \text{ V}_{\text{O}} = 0.8 \text{ V}, \text{ R}_{\text{L}} = 350 \ \Omega$		2	5	mA
Isolation Resistar	Isolation Resistance	RI-0	$V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH} = 40 \text{ to } 60\%,$ $T_A = 25^{\circ}\text{C}$	10 <sup>11</sup>			Ω
	Insulation Resistance (Input-Input), (PS9817A-2)	$R_{I-I} = 1 \text{ kV}_{DC}, RH = 40 \text{ to } 60\%, \\ T_A = 25^{\circ}C$		10 <sup>10</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz, T <sub>A</sub> = 25°C		0.6		pF
	Insulation Capacitance (Input-Input), (PS9817A-2)	CI-I	V = 0 V, f = 1 MHz, T <sub>A</sub> = 25°C		0.3		pF
	Propagation Delay Time	<b>t</b> PHL	T <sub>A</sub> = 25°C		40	75	ns
	$(H\toL)^{*_3}$					100	
	Propagation Delay Time	<b>t</b> PLH	$T_A = 25^{\circ}C$		45	75	
	$(L \rightarrow H)^{*3}$		<u>.</u>			100	
	Rise Time	tr	Vcc = 5.0 V, R∟ = 350 Ω, I⊧ = 7.5 mA		20		
	Fall Time	tr			5		
	Pulse Width Distortion (PWD) <sup>*3</sup>	tphl-tplh			5	35	
	Propagation Delay Skew	tрsк				40	
	Common Mode Transient Immunity at High Level Output <sup>™</sup>	СМн		15	20		kV/ <i>µ</i> s
	Common Mode Transient Immunity at Low Level Output <sup>™</sup>	CM∟	$\label{eq:Vcc} \begin{array}{l} V_{CC} = 5.0 \ V, \ R_L = 350 \ \Omega, \ T_A = 25^\circ C, \\ I_F = 7.5 \ mA, \ V_O < 0.8 \ V, \ V_{CM} = 1 \ kV \end{array}$	15	20		

\*1 Typical values at  $T_A = 25^{\circ}C$ 

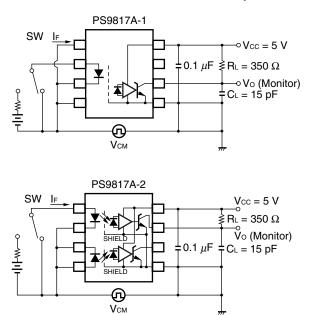
\*2 Because VoL of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.

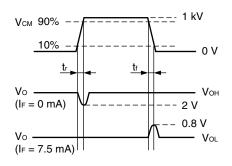
\*3 Test circuit for propagation delay time





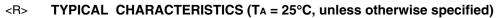
\*4 Test circuit for common mode transient immunity

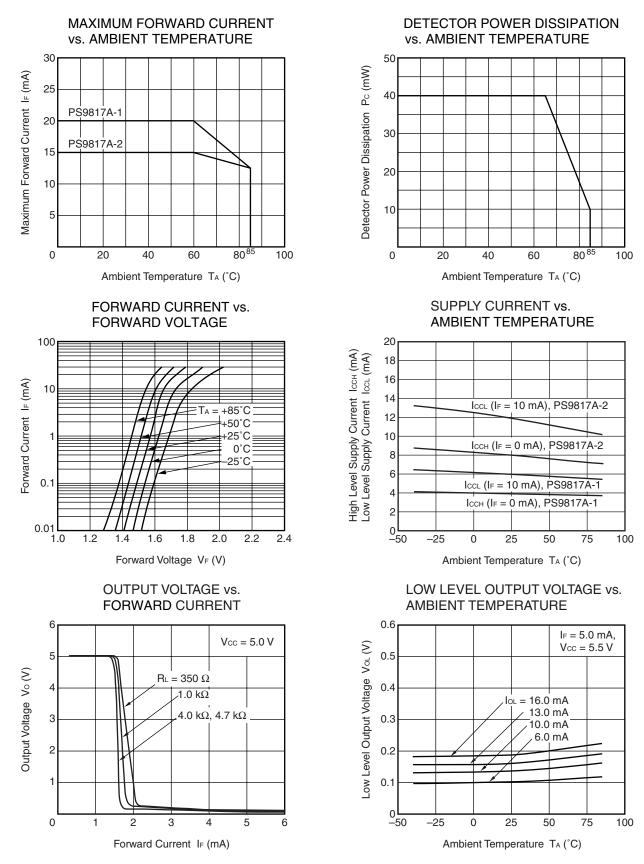




#### **USAGE CAUTIONS**

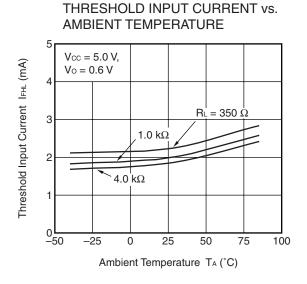
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- **2.** By-pass capacitor of 0.1  $\mu$ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.



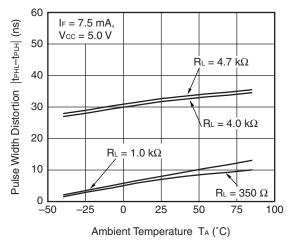




Data Sheet PN10647EJ02V0DS

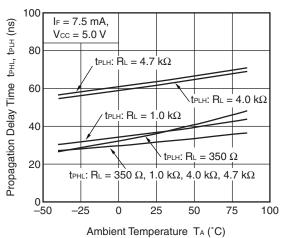


#### PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

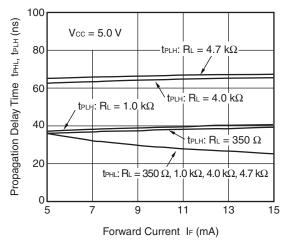


**Remark** The graphs indicate nominal characteristics.

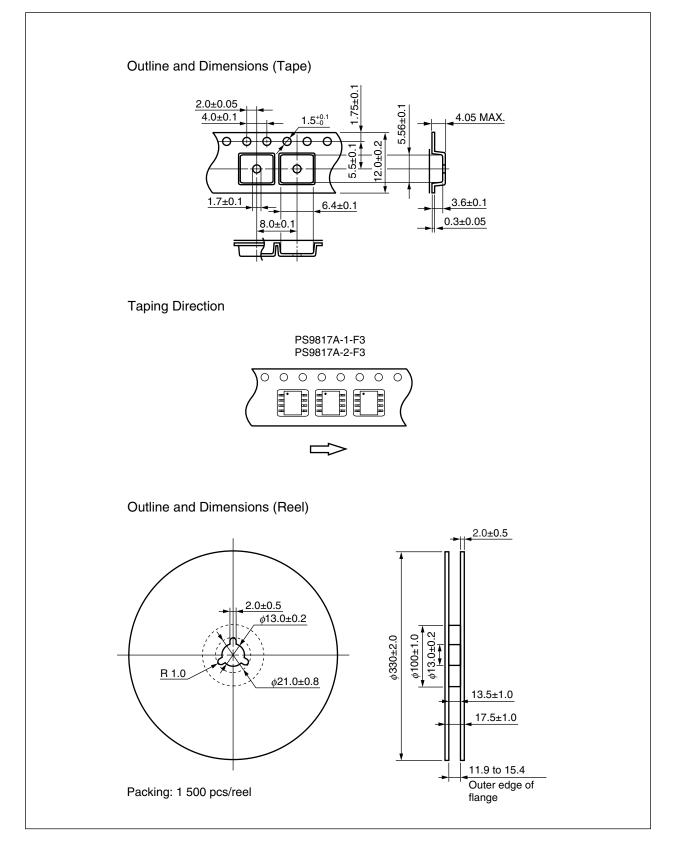
#### PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



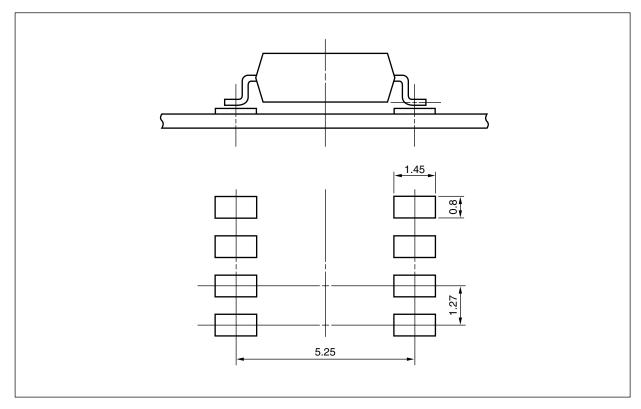
## PROPAGATION DELAY TIME vs. FORWARD CURRENT



#### TAPING SPECIFICATIONS (UNIT: mm)



#### **RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**



#### NOTES ON HANDLING

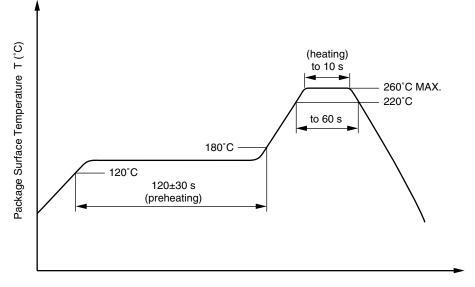
#### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
<ul> <li>Time (each pins)</li> </ul>	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over  $100^{\circ}C$ 

#### (4) Cautions

#### • Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

#### **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.